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OKI Semiconductor MK70110/MK70120

Oki,	Network Solutions
	for a Global Society

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Preliminary

Bluetooth[™] Module

GENERAL DESCRIPTION

The MK70110 and MK70120 are Bluetooth modules that operate in the 2.4 GHz band. Mounted on the board of each of these modules are Bluetooth baseband & RF transceiver IC, RF filter, flash memory, and TCXO. Lower protocol stacks up to the HCI are already installed in these modules as software. These modules can be connected to user's board product by using the connector the modules have. Since the modules are provided not only with the UART and USB interfaces as communication control interfaces but with a PCM interface as a voice control interface, they can cope with any application for data and voice communication.

The MK70110 is equipped with an RF coaxial connector, and the MK70120 has a chip antenna built-in.

By utilizing the MK70110/MK70120, the development TAT for products equipped with Bluetooth can be shortened very effectively.

FEATURES

- Conforms to the Bluetooth Specification Version 1.1
- Optimized design where originally developed LSI chips and authorized Oki software are used
- HCI full module includes Bluetooth baseband IC & RF transceiver IC, flash memory and TCXO
- RF output power: Class 2
- RF I/O: MK70110: RF coaxial connector / MK70120: Internal chip antenna
- Interfaces provided UART interface* (up to 921.6 kbps) USB interface* (USB1.1-conformed) PCM interface (selectable between PCM Linear/A-law/µ-law)
 * Supports HCI commands.

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BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Rating	Unit
Power supply voltage	V _{DD}	Ta = 25°C	-0.3 to 4.5	V
Input voltage	V _{IN}	Ta = 25°C	-0.3 to 4.5	V
Input RF power	—	Ta = 25°C	20	dBm
Storage temperature	T _{stg}	—	-20 to +70	°C

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Power supply voltage	V_{DD}	—	3.2		3.45	V
"H" level input voltage	V _{ih}	—	2.2		3.6	V
"L" level input voltage	V _{il}	—	0		0.8	V
Operating temperature	T _{OP}	—	0	25	50	°C

ELECTRICAL CHARACTERISTICS

Specifications in this section are fulfilled under the conditions that $V_{DD} = 3.3 \text{ V} \pm 0.1 \text{ V}$, Ta = 0 to 50°C. Values of the RF characteristics represent those specified at the edge of the module for both the MK70110 and the MK70120.

General Specifications

Items	Specification	Note
Conformance Crestinetions	Bluetooth Specification	
Conformance Specifications	Version 1.1	—
Power Class	Class 2	—
Frequency range	2,402 to 2,480 MHz	—
Number of channels	79ch	_
Channel separation	1 MHz	_
Modulation method	GFSK	—
RF input-output impedance	Nominal 50 Ω	2,402 to 2,480 MHz
Symbol Rate	1 Mbps	—

DC Characteristics

Output voltage (Applies to digital pins except USB ports)

Parameter	Symbol	Min.	Тур.	Max.	Unit
"H" level output voltage	V _{oh}	2.4		—	V
"L" level output voltage	Vol	—		0.4	V

Output voltage (Applies to USB ports (USB_D+, USB_D-))

Parameter	Symbol	Min.	Тур.	Max.	Unit
"H" level output voltage	V _{oh}	2.8	—	3.6	V
"L" level output voltage	V _{ol}		—	0.3	V

Power consumption (UART interface, with 32 kHz XCLK)

Mode	Тур.	Max.	Unit
Initialize (Stop mode)	10	_	mA
Idle (Cold standby)	6	—	mA
Hold mode (Slave)	40	—	mA
Sniff mode (Slave)	40	_	mA
ACL connection DH1	103	125	mA
SCO connection HV1	113	135	mA

RF Transmission Characteristics

Parameter	Min.	Max.	Unit	Remarks
Output power	-6	+4	dBm	
Frequency deviation	-50	+50	kHz	
Frequency drift				
DH1	-25	+25	kHz	
DH3, DH5	-40	+40	kHz	
Frequency shift				
$\Delta f1_{avg}$: payload = 11110000	140	175	kHz	
$\Delta f2_{max}$: payload = 1010	115	—	kHz	
$\Delta f2_{avg}/\Delta f1_{avg}$	80	—	%	
20 dB band width	_	1	MHz	
In-band spurious emission				Measured by peak detection
Freq. offset = ± 2 MHz	—	-20	dBm	
Freq. offset $\geq \pm 3$ MHz	—	-40	dBm	
Out-of-band spurious emission				
$30 \text{ MHz} \le f < 1 \text{GHz}$	—	-36	dBm	
$1 \text{ GHz} \leq f \leq 12.75 \text{ GHz}$	—	-30	dBm	
1.8 GHz \leq f \leq 1.9 GHz	—	-47	dBm	
5.15 GHz \leq f \leq 5.30 GHz	—	-47	dBm	

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MK70110/MK70120

Reception Characteristics

Parameter	Min.	Max.	Unit	Remarks
Reception sensitivity	_	0.1	%	at –70 dBm input
C/I characteristics				Specification at ordinary temperature
Co-channel	—	14	dB	(Bluetooth Ver.1.1 Test Specification)
Adjacent channel C/I = 1 MHz	—	4	dB	
Adjacent channel C/I = 2 MHz	—	-30 ^{*1}	dB	
Adjacent channel C/I \ge 3 MHz	—	-40 ^{*1}	dB	
Image frequency ^{*2}	—	-6	dB	
Image frequency $\pm 1 \text{ MHz}^{*2}$	—	-16	dB	
Out-of-band blocking				Specification at ordinary temperature
30 MHz ≤ f < 2,000 MHz	-10	—	dBm	
2,000 MHz \leq f \leq 2,399 MHz	-27	—	dBm	
2,498 MHz \leq f < 3,000 MHz	-27	—	dBm	
3,000 MHz \leq f \leq 12.75 GHz	-10	—	dBm	
Intermodulation characteristic	-25	—	dB	Specification at ordinary temperature
Maximum input level	_	0.1	%	Specification at ordinary temperature, at -20 dBm input
Limit of collateral radio waves				Spurious emission during inquiry scan
30 MHz ≤ f < 1 GHz	—	-57	dBm	operation
1 GHz \leq f \leq 12.75 GHz	—	-47	dBm	

*1 Relaxed C/I specification

On five spurious response frequencies with a distance of ≥ 2 MHz from the wanted signal (except for image frequency and image ±1 MHz), a relaxed interference requirement C/I = -17 dB is applied. (According to Bluetooth Specification 1.1, Part A Radio Specification)

- *2 Image Frequencies and adjacent interference to image Image frequency = Co-channel –4 MHz
 - ±1 MHz adjacent interference to image frequency = Co-channel -3 MHz, Co-channel -5 MHz

MECHANICAL CHARACTERISTICS

Weight Specifications

Model Name	Weight
MK70120 (antenna built-in type)	3.6 g (Max.)
MK70110 (RF coaxial connector type)	3.5 g (Max.)

RF I/O Pin Specifications

The following chip antenna and RF coaxial connector are mounted:

Model Name	RF I/O Type	Manufacturer / Model Name
MK70120	Chip antenna	MURATA MFG. / ANCM12G45
MK70110	RF coaxial connector	HIROSE ELECTRIC / U.FL-R-SMT

Connector Specifications

The following board-to-board connector is mounted:

Interface Type	Manufacturer / Series Name
Board-to-board connector	Matsushita Electric Works / AXK6F20345

A header is mounted on the module side.

It is therefore recommended that a 2.0 mm high socket (AXK5F20545) be used against the socket insertion side of the connector.

Board-to-board Connector Detail



PEDLMK70-02

MK70110/MK70120

Pin	Symbol	Туре	Description	If Not Used	
5, 6, 7	V _{DD}	_	Power supply pin ^{*1}	—	
15, 16	GND	_	Ground pin	—	
1	UART_RTS	0	UART Ready To Send (transmission data ready) ^{*2}	Pull_up or V _{DD}	
19	UART_CTS	I	UART Clear To Send (transmission ready) ^{*2} Pull_dov		
2	UART_TD	0	UART transmission data	Pull_up or V _{DD}	
20	UART_RD	I	UART receive data	Pull_up or V _{DD}	
12	USB_D+	I/O	USB Data +	Open	
9	USB_D-	I/O	USB Data –	Open	
13	VBUS	I	HCI transport selection pin H: USB is used as HCI L: UART is used as HCI adhering to the above logic at power-on	_	
4	PCM_OUT	0	PCM data output	Open	
17	PCM_IN	I	PCM data input ^{*5}	Open	
3	PCM_CLK	0	PCM clock output (64 kHz/128 kHz) ^{*5}	Open	
18	PCM_SYNC	0	PCM synchronous signal input (8 kHz) ^{*5}	Open	
8	RESET ^{*6}	I	Reset signal input pin Reset = L Effective reset pulse width > 10 µsec	Pull_up	
14	XCLK	Ι	Subclock input pin 32 kHz ^{*3}	GND	
11	TEST1	Ι	Test pin for our company's use ^{*4}	Open	
10	N.C	_	N.C.	Open	

CONNECTOR PIN DESCRIPTIONS

*1 Mount an approximately 10 μF tantalum or electrolytic capacitor to the power supply input pin.

The capacitor should be mounted as close to the power supply pin of the module as possible.

*2 At present, this pin is not supported. Must be left open.

*3 At present, this pin does not support a 32 kHz sub-clock. Connect to GND.

*4 Test pin for our company's use. Must be left open.

*5 The PCM_IN, CLK, and SYNC pins are pulled-down internally.

*6 Setting the reset signal input pin RESET to a "L" level can reset the LSI. The reset state of the LSI is held for a duration of 10 msec even after the reset signal is switched to a "H" level.

INTERFACE SPECIFICATIONS

USB Interface

- Conforms to USB1.1
- Supports 12 Mbps

Parameter	Symbol	Condition [1], [2], [3]	Min.	Тур.	Max.	Unit	
Rise time	TR	C = 50 pF	4	—	20	ns	
Fall time	TF	$C_L = 50 \text{ pr}$	4	_	20		
Output signal crossover voltage	VCRS	$C_L = 50 \text{ pF}$	1.3	—	2	V	
Driver output resistance	ZDRV	When being driven in a steady state	28	—	44	Ω	
Data rate	TDRATE	Average bit rate (12 Mbps ±0.25%)	11.97	_	12.03	Mbps	

- [1] TR and TF are the intervals of the transition time from 10% to 90% (TR) or from 90% to 10% (TF) of an amplitude.
- [2] Input signal crossover point (When USB connector is not attached)



UART Interface

Various settings can be made for the UART interface by using the Vendor specific command (refer to the ML70110/MK70120 User's Manual).

The default values are as follows:

- Baud rate: 115.2 kbps
- Parity: Non-parity
- Data length: 8 bits
- Stop bit: 1 bit
- Flow control: off

PCM Interface

- Application format PCM linear (8, 16 bits/sample, 64 kHz sampling frequency)/A-law/µ-law
- Bluetooth format CVSD/A-law/µ-law

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MK70110/MK70120



PCM Output Timing





PEDLMK70-02

MK70110/MK70120

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
PCMIN setup time to PCMCLK (input) fall			500	_	_	
PCMIN hold time to PCMCLK (input) fall	t _{PC1}		500	_	_	
PCMOUT setup time to PCMCLK (input) rise	t _{PC2}	500 500 500 500 C _L = 50 —	500	_	_	
PCMOUT hold time to PCMCLK (input) rise	t _{PC3}		_	_		
PCMSYNC (input) setup time to PCMCLK (input) rise	t _{PC4}		500	_	_	
PCMSYNC (input) hold time to PCMCLK (input) rise	t _{PC5}		_	_		
Delay time from PCMCLK (input) rise to PCMSYNC (output)	t _{PC6}		_	500		
PCMIN setup time to PCMCLK (output) fall	t _{PC7}	pF	500	_	_	ns
PCMIN hold time to PCMCLK (output) fall	t _{PC8}	500	500	_	_	
PCMOUT setup time to PCMCLK (output) rise	t _{PC9}		500	_	_	
PCMOUT hold time to PCMCLK (output) rise		500	_	_		
PCMSYNC (input) setup time to PCMCLK (output) rise	t _{PC11}	500	_	_		
PCMSYNC (input) hold time to PCMCLK (output) rise	t _{PC12}		500	_	_	
Delay time from PCMCLK (output) rise to PCMSYNC (output)	t _{PC13}		_	_	500	

PCM Timing Specifications



PCM Timing

MOUNTING MODULE

Recommended Module Fixing Method

When this module is fixed on a product, our recommended method is to fit the module board-to-board connector (header) into the board-to-board connector (socket) mounted on the product board, and to solder the module shielding case to the product board.

The pattern inhibiting zone is applied to the MK70120 (antenna built-in type).

Soldering points in the shielding case for fixation on a product board

Notes on Mounting the Module

- 1. This module is not adaptable to reflow mounting. When soldering the shielding case to a product board, use a soldering iron.
- 2. If metal is placed around the antenna, the antenna characteristics may deteriorate. Do not place copper foil in the pattern inhibiting zone shown in the above section. Do not place metal around the antenna if possible. (Only for MK70120).
- 3. The shielding case is connected to GND in the module. For mounting the module, when pattern wiring that touches the shielding case is carried out on the product board, do not cause a short-circuit between the shielding case and the pattern. For example, apply resist on the entire surface that touches the shielding case.
- 4. The effects of noise on a product board depend on the connection of GND/NC to the fixation pads. Select the connection with better electrical characteristics in the module mounted state.

CAUTIONS IN USE

This module consists of precision electronic components. Therefore, note the following when handling the module:

- 1. In a case of decomposition or recomposition of this module, the operations in these specifications are not assured.
- 2. This module is not waterproof or drip-proof. Do not use the module in wet locations.
- 3. Do not use this module under high temperature or high humidity conditions, in direct sunlight, or in dusty places.

MODULE OUTLINE

Outline of MK70110

Outline of MK70120

REVISION HISTORY

Document		Page				
No.	Date	Previous Edition	Current Edition	Description		
PEDLMK70-01	Aug. 2001	-	-	Preliminary edition 1		
	Apr. 24, 2002	-	_	Preliminary edition 2		
PEDLMK70-02				Owing to the device name change from MK70 Series to MK70110/MK70120, the contents have been changed throughout the document.		

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